

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: Akira MATSUDA et al.

Group Art Unit: 1775

Serial No.: 10/719,020

Examiner: Robert R. Koehler

Filed: November 24, 2003

Confirmation No.: 9168

For:

PLATING BATH FOR FORMING THIN RESISTANCE LAYER, METHOD OF FORMATION OF RESISTANCE LAYER, CONDUCTIVE BASE WITH RESISTANCE LAYER, AND CIRCUIT BOARD MATERIAL WITH RESISTANCE LAYER

Attorney Docket Number: 032130
Customer Number: 38834

PETITION FOR EXTENSION OF TIME

Commissioner for Patents P. O. Box 1450 Alexandria, VA 22313-1450

Date: July 5, 2005

Sir:

Applicants petition the Commissioner for Patents to extend the time for response to the Office Action dated March 4, 2005 for one month from June 4, 2005 to July 4, 2005.

Attached please find a check in the amount of \$\frac{\\$120.00}{2}\$ to cover the cost of the extension. If any additional fees are due in connection with this paper, please charge our Deposit Account No. 50-2866.

Respectfully submitted,

WESTERMAN, HATTORI, DANIELS & ADRIAN, LLP

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